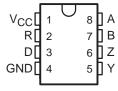
SLLS003E - OCTOBER 1985 - REVISED JUNE 1998

- Meets or Exceeds the Requirements of TIA/EIA-422-B, TIA/EIA-485-A, and ITU **Recommendation V.11**
- Bus Voltage Range . . . 7 V to 12 V
- Positive- and Negative-Current Limiting
- Driver Output Capability . . . 60 mA Max
- **Driver Thermal-Shutdown Protection**
- Receiver Input Impedance . . . 12 k Ω Min
- Receiver Input Sensitivity . . . ±200 mV
- Receiver Input Hysteresis . . . 50 mV Typ
- **Operates From Single 5-V Supply**
- **Low Power Requirements**

D OR P PACKAGE (TOP VIEW)



description

The SN75179B is a differential driver and receiver pair designed for balanced transmission-line applications and meets TIA/EIA-422-B, TIA/EIA-485-A, and ITU Recommendation V.11. It is designed to improve the performance of full-duplex data communications over long bus lines.

The SN75179B driver output provides limiting for both positive and negative currents. The receiver features high input impedance, input hysteresis for increased noise immunity, and input sensitivity of ±200 mV over a common-mode input voltage range of -7~V to 12 V. The driver provides thermal shutdown for protection from line fault conditions. Thermal shutdown is designed to occur at a junction temperature of approximately 150°C. The SN75179B is designed to drive current loads of up to 60 mA maximum.

The SN75179B is characterized for operation from 0°C to 70°C.

Function Tables

DRIVER

| INPUT | OUTPUTS | | | | |
|-------|---------|---|--|--|--|
| D | Υ | Z | | | |
| Н | Н | L | | | |
| L | L | Н | | | |

RECEIVER

| DIFFERENTIAL INPUTS A – B | OUTPUT R |
|--|-------------|
| V _{ID} ≥ 0.2 V | Н |
| $-0.2 \text{ V} < \text{V}_{1D} < 0.2 \text{ V}$ | ? |
| $V_{ID} \le -0.2 V$ | L |
| Open | ? |

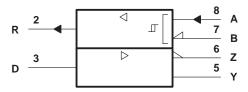
H = high level, L = low level, ? = indeterminate



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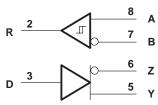


logic symbol[†]

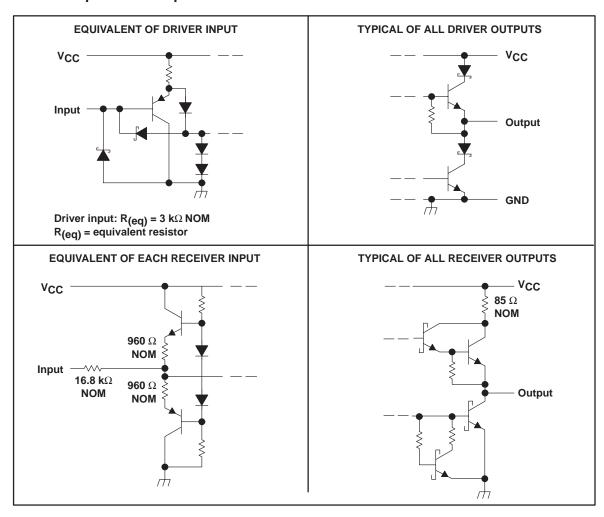


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



schematics of inputs and outputs





SN75179B DIFFERENTIAL DRIVER AND RECEIVER PAIR

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage, V _{CC} (see Note 1) | |
|--|----------------|
| Voltage range at any bus terminal | |
| Differential input voltage, V _{ID} (see Note 2) | ±25\ |
| Package thermal impedance, θ_{JA} (see Note 3): D package | 197°C/V |
| P package | 104°C/V |
| Storage temperature range, T _{stg} | –65°C to 150°C |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | 260°C |

- NOTES: 1. All voltage values, except differential input voltage, are with respect to network ground terminal.
 - 2. Differential input voltage is measured at the noninverting input with respect to the corresponding inverting input.
 - 3. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions

| | | | MIN | NOM | MAX | UNIT |
|--|----------|-----------------|------|-----|------|------|
| Supply voltage, V _{CC} | | | 4.75 | 5 | 5.25 | V |
| High-level input voltage, VIH | Driver | | 2 | | | V |
| Low-level input voltage, V _{IL} | Driver | | | | 0.8 | V |
| Common-mode input voltage, V _{IC} | | _7 [‡] | | 12 | V | |
| Differential input voltage, V _{ID} | | | | ±12 | V | |
| High level cutout current leve | Driver | | | | -60 | mA |
| High-level output current, IOH | Receiver | | | | -400 | μΑ |
| Driver | | | | | 60 | A |
| Low-level output current, IOL | Receiver | | | | 8 | mA |
| Operating free-air temperature, T _A | | 0 | | 70 | °C | |

[‡] The algebraic convention, where the less positive (more negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DRIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | | MIN | TYP [†] | MAX | UNIT |
|----------------------|--|---|---------------------------------------|------------------------------|------------------|---------|------|
| ٧ _{IK} | Input clamp voltage | I _I = -18 mA | | | | -1.5 | V |
| VO | Output voltage | IO = 0 | | 0 | | 6 | V |
| v _{OD1} | Differential output voltage | IO = 0 | | 1.5 | | 6 | V |
| l V _{OD2} l | Differential output voltage | R _L = 100 Ω, | See Figure 1 | 1/2V _{OD1} or 2‡ | | | V |
| | | $R_L = 54 \Omega$, | See Figure 1 | 1.5 | 2.5 | 5 | V |
| V _{OD3} | Differential output voltage | See Note 4 | | 1.5 | | 5 | V |
| ∆ V _{OD} I | Change in magnitude of common-mode output voltage§ | | | | | ±0.2 | V |
| Voc | Common-mode output voltage | $R_L = 54 \Omega \text{ or } 100 \Omega,$ | See Figure 1 | | | 3 -1 | V |
| ∆ V _{OC} I | Change in magnitude of common-mode output voltage§ | | | | | ±0.2 | V |
| lo | Output current | $V_{CC} = 0$, | $V_0 = -7 \text{ V to } 12 \text{ V}$ | | | ±100 | μА |
| ΙΗ | High-level input current | V _I = 2.4 V | | | | 20 | μА |
| Ι _Ι L | Low-level input current | V _I = 0.4 V | | | | -200 | μΑ |
| la a | Short-circuit output current | V _O = -7 V | | | | -250 | A |
| los | | $V_O = V_{CC}$ or 12 V | | | | 250 | mA |
| Icc | Supply current (total package) | No load | _ | | 57 | 70 | mA |

 $^{^{\}dagger}$ All typical values are at V_{CC} = 5 V and T_A = 25°C.

NOTE 4: See TIA/EIA-485-A, Figure 3.5, Test Termination Measurement 2.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

| | PARAMETER | TEST CONDITIONS | | MIN | TYP | MAX | UNIT |
|---------------------|-------------------------------------|---------------------|--------------|-----|-----|-----|------|
| td(OD) | Differential output delay time | D: -54 O | See Figure 3 | | 15 | 22 | ns |
| t _t (OD) | Differential output transition time | $R_L = 54 \Omega$, | | | 20 | 30 | ns |

Symbol Equivalents

| DATA-SHEET PARAMETER | TIA/EIA-422-B | TIA/EIA-485-A |
|----------------------|-----------------------------------|---|
| Vo | V _{oa} , V _{ob} | V _{oa} , V _{ob} |
| VOD1 | Vo | Vo |
| IV _{OD2} I | $V_t (R_L = 100 \Omega)$ | $V_t (R_L = 54 \Omega)$ |
| V _{OD3} | | V _t (Test Termination Measurement 2) |
| Δ V _{OD} | $ V_t - \overline{V}_t $ | $ V_t - \overline{V}_t $ |
| Voc | V _{os} | V _{os} |
| Δ VOC | $ V_{OS} - \overline{V}_{OS} $ | $ V_{OS} - \overline{V}_{OS} $ |
| los | $ I_{sa} , I_{sb} $ | |
| IO | _{xa} , _{xb} | l _{ia} , l _{ib} |



 $[\]ddagger$ The minimum VOD2 with 100- Ω load is either 1/2 VOD2 or 2 V, whichever is greater.

[§] Δ|V_{OD}| and Δ|V_{OC}| are the changes in magnitude of V_{OD} and V_{OC}, respectively, that occur when the input changes from a high level to a low level

RECEIVER SECTION

electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

| | PARAMETER | TE | TEST CONDITIONS | | MIN | TYP [†] | MAX | UNIT |
|------------------|---|-----------------------------|--------------------------|-----------------------|-------|------------------|------|------|
| V _{IT+} | Positive-going input threshold voltage | $V_0 = 2.7 V$, | $I_0 = -0.4 \text{ mA}$ | | | | 0.2 | V |
| VIT- | Negative-going input threshold voltage | $V_0 = 0.5 V$, | I _O = 8 mA | | -0.2‡ | | | V |
| V _{hys} | Hysteresis voltage (V _{IT+} – V _{IT-}) | | | | | 50 | | mV |
| Vон | High-level output voltage | $V_{ID} = 200 \text{ mV},$ | $I_{OH} = -400 \mu A$, | See Figure 2 | 2.7 | | | V |
| VOL | Low-level output voltage | $V_{ID} = -200 \text{ mV},$ | $I_{OL} = 8 \text{ mA},$ | See Figure 2 | | | 0.45 | V |
| 1. | Line input current | Other input at 0 V, | See Note 5 | V _I = 12 V | | | 1 | mA |
| <u> </u> | Line input current | Other input at 0 v, | See Note 5 | $V_I = -7 V$ | | | -0.8 | IIIA |
| rį | Input resistance | | | | 12 | | | kΩ |
| los | Short-circuit output current | | | | -15 | | -85 | mA |
| ICC | Supply current (total package) | No load | No load | | | 57 | 70 | mA |

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

NOTE 5: Refer to TIA/EIA-422-B for exact conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------|---|--|-----|-----|-----|------|
| ^t PLH | Propagation delay time, low- to high-level output | $V_{ID} = -1.5 \text{ V to } 1.5 \text{ V},$ | | 19 | 35 | ns |
| ^t PHL | Propagation delay time, high- to low-level output | C _L = 15 pF, See Figure 4 | | 30 | 40 | ns |

PARAMETER MEASUREMENT INFORMATION

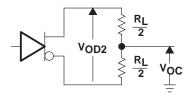


Figure 1. Driver V_{DD} and V_{OC}

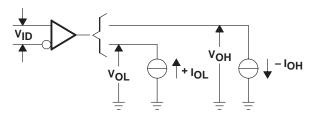
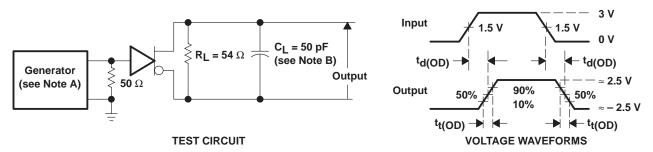


Figure 2. Receiver VOH and VOL

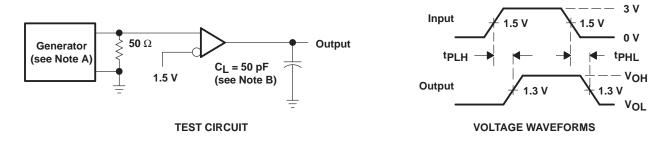
[‡] The algebraic convention, where the less positive (more negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.

PARAMETER MEASUREMENT INFORMATION (CONTINUED)



- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $t_f \leq$ 6 ns, $t_f \leq$ 7 ns, $t_f \leq$ 8 ns, $t_f \leq$ 8 ns, $t_f \leq$ 8 ns, $t_f \leq$ 9 ns, t_f
 - B. C_L includes probe and jig capacitance.

Figure 3. Driver Test Circuit and Voltage Waveforms



- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $t_\Gamma \leq$ 6 ns, $t_f \leq$ 7 ns, $t_f \leq$ 8 ns, $t_f \leq$ 8 ns, $t_f \leq$ 8 ns, $t_f \leq$ 8 ns, $t_f \leq$ 9 ns, t_f
 - B. C₁ includes probe and jig capacitance.

Figure 4. Receiver Test Circuit and Voltage Waveforms



TYPICAL CHARACTERISTICS

DRIVER **HIGH-LEVEL OUTPUT VOLTAGE** vs **HIGH-LEVEL OUTPUT CURRENT** 5 V_{CC} = 5 V 4.5 T_A = 25°C VOH − High-Level Output Voltage − V 4 3.5 3 2.5 2 1.5 1 0.5 0 0 - 20 -40-60- 80 -100- 120 IOH - High-Level Output Current - mA

DRIVER
LOW-LEVEL OUTPUT VOLTAGE
vs
LOW-LEVEL OUTPUT CURRENT

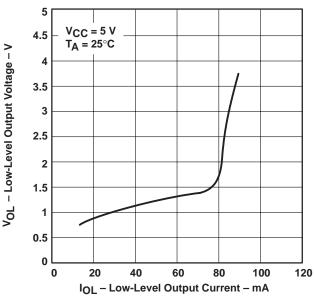
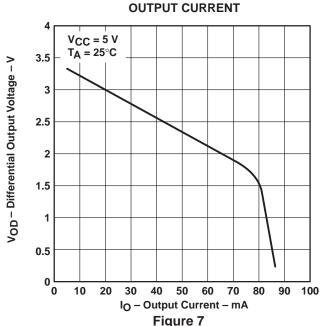


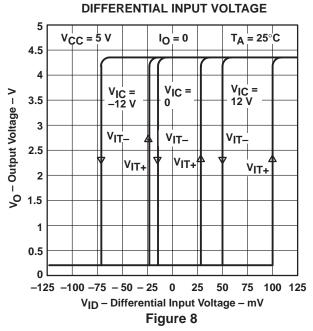
Figure 6



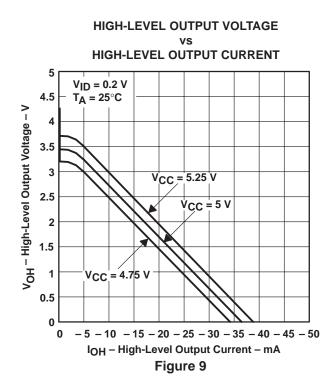
Figure 5

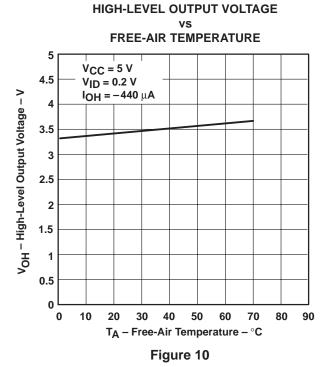


RECEIVER OUTPUT VOLTAGE VS



TYPICAL CHARACTERISTICS





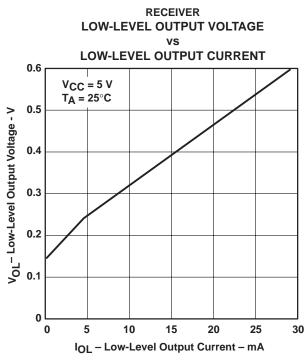
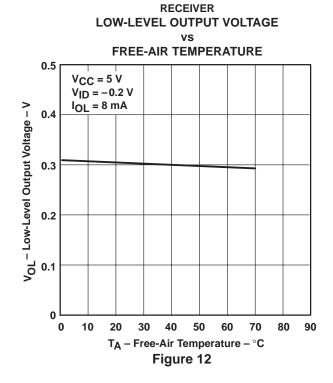


Figure 11



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